July 1999

DS90LV031A 3V LVDS Quad CMOS Differential Line Driver

General Description

The DS90LV031A is a quad CMOS differential line driver designed for applications requiring ultra low power dissipation and high data rates. The device is designed to support data rates in excess of 400 Mbps (200 MHz) utilizing Low Voltage Differential Signaling (LVDS) technology.

The DS90LV031A accepts low voltage TTL/CMOS input levels and translates them to low voltage (350 mV) differential output signals. In addition the driver supports a TRI-STATE® truction that may be used to disable the output stage, disabling the load current, and thus dropping the device to an ultra low idle power state of 13 mW typical.

The EN and EN* inputs allow active Low or active High control of the TRI-STATE outputs. The enables are common to all four drivers. The DS90LV031A and companion line receiver (DS90LV032A) provide a new alternative to high power psuedo-ECL devices for high speed point-to-point interface applications.

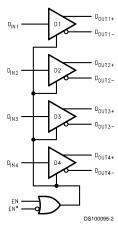
Features

- >400 Mbps (200 MHz) switching rates
- 0.1 ns typical differential skew
- 0.4 ns maximum differential skew
- 2.0 ns maximum propagation delay
- 3.3V power supply design
- ±350 mV differential signaling
- Low power dissipation (13mW at 3.3V static)
- Interoperable with existing 5V LVDS devices
- Compatible with IEEE 1596.3 SCI LVDS standard
- Compatible with TIA/EIA-644 LVDS standard
- Industrial and Military operating temperature range
- Available in SOIC, TSSOP and Cerpack surface mount packaging
- Standard Microcircuit Drawing (SMD) 5962-9865201

Connection Diagram

Order Number DS90LV031ATM
or DS90LV031ATMTC
or DS90LV031AW
See NS Package Number M16A or MTC16 or W16A

Functional Diagram



Truth Table

DRIVER

Enables		Input	Outputs		
EN	EN*	D _{IN}	D _{OUT+}	D _{OUT}	
L	Н	Х	Z	Z	
All other com		L	L	Н	
ENABLE inpu	ıts				
		Н	Н	L	

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Short Circuit Duration

(D_{OUT+}, D_{OUT-})

Maximum Package Power Dissipation @ +25°C

M Package

MTC Package

W Package

Derate M Package

Derate MTC Package

Derate W Package

6.8 mW/°C above +25°C

Recommended Operating Conditions

	Min	Тур	Max	Units
Supply Voltage (V _{CC})	+3.0	+3.3	+3.6	V
Operating Free Air Temperature (T _A)				
Industrial	-40	+25	+85	°C
Military	-55	+25	+125	°C

Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified. (Notes 2, 3, 4)

Symbol	Parameter	Conditions	Pin	Min	Тур	Max	Units
V _{OD1}	Differential Output Voltage	$R_L = 100\Omega (Figure 1)$	D _{OUT}	250	350	450	mV
ΔV_{OD1}	Change in Magnitude of V _{OD1} for Complementary Output States		D _{OUT+}		4	35	mV
Vos	Offset Voltage			1.125	1.25	1.375	V
ΔV_{OS}	Change in Magnitude of V _{OS} for Complementary Output States				5	25	mV
V _{OH}	Output Voltage High				1.38	1.6	V
V_{OL}	Output Voltage Low			0.90	1.03		V
V _{IH}	Input Voltage High		D _{IN} ,	2.0		V _{CC}	V
V _{IL}	Input Voltage Low		EN,	GND		0.8	V
I _{IH}	Input Current	$V_{IN} = V_{CC}$ or 2.5V	EN*	-10	±1	+10	μΑ
I _{IL}	Input Current	V _{IN} = GND or 0.4V		-10	±1	+10	μΑ
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA		-1.5	-0.8		V
I _{os}	Output Short Circuit Current	ENABLED, (Note 11) $D_{IN} = V_{CC}, D_{OUT+} = 0V \text{ or}$ $D_{IN} = GND, D_{OUT-} = 0V$	D _{OUT-}		-6.0	-9.0	mA
I _{OSD}	Differential Output Short Circuit Current	ENABLED, V _{OD} = 0V (Note 11)			-6.0	-9.0	mA
I _{OFF}	Power-off Leakage	V _{OUT} = 0V or 3.6V, V _{CC} = 0V or Open		-20	±1	+20	μA
l _{oz}	Output TRI-STATE Current	$EN = 0.8V$ and $EN^* = 2.0V$ $V_{OUT} = 0V$ or V_{CC}		-10	±1	+10	μA
I _{cc}	No Load Supply Current Drivers Enabled	D _{IN} = V _{CC} or GND	V _{cc}		5.0	8.0	mA
I _{CCL}	Loaded Supply Current Drivers Enabled	$R_L = 100\Omega$ All Channels, $D_{IN} = V_{CC}$ or GND (all inputs)]		23	30	mA
I _{CCZ}	No Load Supply Current Drivers Disabled	$D_{IN} = V_{CC}$ or GND, EN = GND, EN* = V_{CC}			2.6	6.0	mA

Switching Characteristics - Industrial

 V_{CC} = +3.3V ±10%, T_A = -40°C to +85°C (Notes 3, 9, 12)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{PHLD}	Differential Propagation Delay High to Low	$R_L = 100\Omega, C_L = 10 pF$	0.8	1.18	2.0	ns
t _{PLHD}	Differential Propagation Delay Low to High	(Figure 2 and Figure 3)	0.8	1.25	2.0	ns
t _{SKD1}			0	0.07	0.4	ns
t _{SKD2}	Channel-to-Channel Skew (Note 6)	1	0	0.1	0.5	ns
t _{SKD3}	Differential Part to Part Skew (Note 7)	1	0		1.0	ns
t _{SKD4}	Differential Part to Part Skew (Note 8)	1	0		1.2	ns
t _{TLH}	Rise Time	1		0.38	1.5	ns
t _{THL}	Fall Time	1		0.40	1.5	ns
t _{PHZ}	Disable Time High to Z	$R_L = 100\Omega, C_L = 10 pF$			5	ns
t _{PLZ}	Disable Time Low to Z	(Figure 4 and Figure 5)			5	ns
t _{PZH}	Enable Time Z to High	1			7	ns
t _{PZL}	Enable Time Z to Low	1			7	ns
f _{MAX}	Maximum Operating Frequency (Note 14)		200	250		MHz

Switching Characteristics - Military

 $V_{CC} = +3.3V \pm 10\%$, $T_A = -55^{\circ}C$ to $+125^{\circ}C$ (Notes 9, 12)

Symbol	Parameter	Conditions	Min	Max	Units
t _{PHLD}	Differential Propagation Delay High to Low	$R_L = 100\Omega, C_L = 10 pF$	0.8	2.0	ns
t _{PLHD}	Differential Propagation Delay Low to High	(Figure 2 and Figure 3)	0.8	2.0	ns
t _{SKD1}	Differential Pulse Skew t _{PHLD} - t _{PLHD} (Note 5)		0	0.4	ns
t _{SKD2}	Channel-to-Channel Skew (Note 6)		0	0.5	ns
t _{SKD3}	Differential Part to Part Skew (Note 7)		0	1.0	ns
t _{SKD4}	Differential Part to Part Skew (Note 8)		0	1.2	ns
t _{TLH}	Rise Time			1.5	ns
t _{THL}	Fall Time			1.5	ns
t _{PHZ}	Disable Time High to Z	$R_L = 100\Omega, C_L = 10 pF$		5	ns
t _{PLZ}	Disable Time Low to Z	(Figure 4 and Figure 5)		5	ns
t _{PZH}	Enable Time Z to High			7	ns
t _{PZL}	Enable Time Z to Low			7	ns
f _{MAX}	Maximum Operating Frequency (Note 14)		200		MHz

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except: V_{OD1} and ΔV_{OD1} .

Note 3: All typicals are given for: V_{CC} = +3.3V, T_A = +25°C.

Note 4: The DS90LV031A is a current mode device and only functions within datasheet specifications when a resistive load is applied to the driver outputs typical range is $(90\Omega \text{ to } 110\Omega)$

Note 5: t_{SKD1}, |t_{PHLD} - t_{PLHD}| is the magnitude difference in differential propagation delay time between the positive going edge and the negative going edge of the same channel.

Note 6: t_{SKD2} is the Differential Channel-to-Channel Skew of any event on the same device.

Note 7: t_{SKD3} , Differential Part to Part Skew, is defined as the difference between the minimum and maximum specified differential propagation delays. This specification applies to devices at the same V_{CC} and within 5°C of each other within the operating temperature range.

Note 8: t_{SKD4} , part to part skew, is the differential channel-to-channel skew of any event between devices. This specification applies to devices over recommended operating temperature and voltage ranges, and across process distribution. t_{SKD4} is defined as |Max - Min| differential propagation delay.

 $\textbf{Note 9:} \quad \text{Generator waveform for all tests unless otherwise specified: } f = 1 \text{ MHz}, \ Z_O = 50\Omega, \ t_f \leq 1 \text{ ns, and } t_f \leq 1 \text{ ns.}$

Note 10: ESD Ratings:

HBM (1.5 k Ω , 100 pF) \geq 6 kV

Note 11: Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only.

Note 12: C_L includes probe and jig capacitance.

Note 13: All input voltages are for one channel unless otherwise specified. Other inputs are set to GND.

Note 14: f_{MAX} generator input conditions: $t_r = t_f < 1$ ns, (0% to 100%), 50% duty cycle, 0V to 3V. Output Criteria: duty cycle = 45%/55%, VOD > 250mV, all channels switching.

Parameter Measurement Information

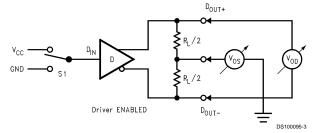


FIGURE 1. Driver $\rm V_{OD}$ and $\rm V_{OS}$ Test Circuit

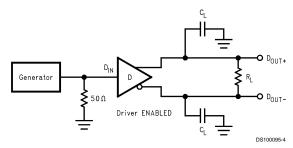


FIGURE 2. Driver Propagation Delay and Transition Time Test Circuit

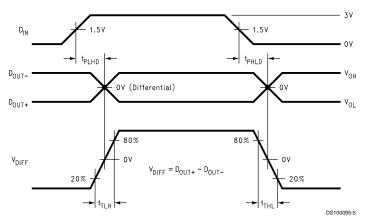


FIGURE 3. Driver Propagation Delay and Transition Time Waveforms

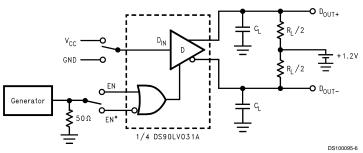


FIGURE 4. Driver TRI-STATE Delay Test Circuit

Parameter Measurement Information (Continued)

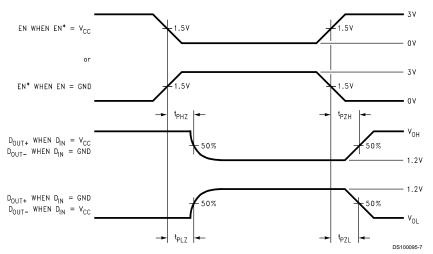


FIGURE 5. Driver TRI-STATE Delay Waveform

Typical Application

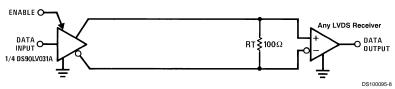


FIGURE 6. Point-to-Point Application

Applications Information

General application guidelines and hints for LVDS drivers and receivers may be found in the following application notes: LVDS Owner's Manual (lit #550062-001), AN808, AN1035, AN977, AN971, AN916, AN805, AN903.

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as is shown in Figure 6. This configuration provides a clean signaling environment for the quick edge rates of the drivers. The receiver is connected to the driver through a balanced media which may be a standard twisted pair cable, a parallel pair cable, or simply PCB traces. Typically, the characteristic differential impedance of the media is in the range of 100Ω . A termination resistor of 100Ω should be selected to match the media, and is located as close to the receiver input pins as possible. The termination resistor converts the current sourced by the driver into a voltage that is detected by the receiver. Other configurations are possible such as a multi-receiver configuration, but the effects of a mid-stream connector(s), cable stub(s), and other impedance discontinuities as well as ground shifting, noise margin limits, and total termination loading must be taken into account.

The DS90LV031A differential line driver is a balanced current source design. A current mode driver, generally speaking has a high output impedance and supplies a constant current for a range of loads (a voltage mode driver on the other hand supplies a constant voltage for a range of loads). Current is switched through the load in one direction to pro-

duce a logic state and in the other direction to produce the other logic state. The output current is typically 3.5 mA, a minimum of 2.5 mA, and a maximum of 4.5 mA. The current mode **requires** (as discussed above) that a resistive termination be employed to terminate the signal and to complete the loop as shown in Figure~6. AC or unterminated configurations are not allowed. The 3.5 mA loop current will develop a differential voltage of 350 mV across the 100Ω termination resistor which the receiver detects with a 250 mV minimum differential noise margin neglecting resistive line losses (driven signal minus receiver threshold (350 mV - 100 mV = 250 mV)). The signal is centered around +1.2V (Driver Offset, $V_{\rm OS}$) with respect to ground as shown in Figure~7. Note that the steady-state voltage ($V_{\rm OS}$) peak-to-peak swing is twice the differential voltage ($V_{\rm OD}$) and is typically 700 mV.

The current mode driver provides substantial benefits over voltage mode drivers, such as an RS-422 driver. Its quiescent current remains relatively flat versus switching frequency. Whereas the RS-422 voltage mode driver increases exponentially in most case between 20 MHz–50 MHz. This is due to the overlap current that flows between the rails of the device when the internal gates switch. Whereas the current mode driver switches a fixed current between its output without any substantial overlap current. This is similar to some ECL and PECL devices, but without the heavy static $I_{\rm CC}$ requirements of the ECL/PECL designs. LVDS requires > 80% less current than similar PECL devices. AC specifications for the driver are a tenfold improvement over other existing RS-422 drivers.

Applications Information (Continued)

The TRI-STATE function allows the driver outputs to be disabled, thus obtaining an even lower power state when the transmission of data is not required.

The footprint of the DS90LV031A is the same as the industry standard 26LS31 Quad Differential (RS-422) Driver and is a step down replacement for the 5V DS90C031 Quad Driver.

Power Decoupling Recommendations:

Bypass capacitors must be used on power pins. High frequency ceramic (surface mount is recommended) $0.1\mu F$ in parallel with $0.01\mu F$, in parallel with $0.001\mu F$ at the power supply pin as well as scattered capacitors over the printed circuit board. Multiple vias should be used to connect the decoupling capacitors to the power planes. A $10\mu F$ (35V) or greater solid tantalum capacitor should be connected at the power entry point on the printed circuit board.

PC Board considerations:

Use at least 4 PCB layers (top to bottom); LVDS signals, ground, power, TTL signals.

Isolate TTL signals from LVDS signals, otherwise the TTL may couple onto the LVDS lines. It is best to put TTL and LVDS signals on different layers which are isolated by a power/ground plane(s).

Keep drivers and receivers as close to the (LVDS port side) connectors as possible.

Differential Traces:

Use controlled impedance traces which match the differential impedance of your transmission medium (ie. cable) and termination resistor. Run the differential pair trace lines as close together as possible as soon as they leave the IC (stubs should be < 10mm long). This will help eliminate reflections and ensure noise is coupled as common-mode. In fact, we have seen that differential signals which are 1mm apart radiate far less noise than traces 3mm apart since magnetic field cancellation is much better with the closer traces. Plus, noise induced on the differential lines is much more likely to appear as common-mode which is rejected by the receiver.

Match electrical lengths between traces to reduce skew. Skew between the signals of a pair means a phase difference between signals which destroys the magnetic field cancellation benefits of differential signals and EMI will result. (Note the velocity of propagation, v = c/Er where c (the speed of light) = 0.2997mm/ps or 0.0118 in/ps). Do not rely solely on the autoroute function for differential traces. Carefully review dimensions to match differential impedance and provide isolation for the differential lines. Minimize the number or vias and other discontinuities on the line.

Avoid 90° turns (these cause impedance discontinuities). Use arcs or 45° bevels.

Within a pair of traces, the distance between the two traces should be minimized to maintain common-mode rejection of the receivers. On the printed circuit board, this distance should remain constant to avoid discontinuities in differential impedance. Minor violations at connection points are allowable

Termination:

Use a resistor which best matches the differential impedance or your transmission line. The resistor should be between 90Ω and 130Ω . Remember that the current mode outputs need the termination resistor to generate the differential voltage. LVDS will not work without resistor termination. Typically, connect a single resistor across the pair at the receiver end.

Surface mount 1% to 2% resistors are best. PCB stubs, component lead, and the distance from the termination to the receiver inputs should be minimized. The distance between the termination resistor and the receiver should be < 10mm (12mm MAX).

Probing LVDS Transmission Lines:

Always use high impedance (> $100k\Omega$), low capacitance (< 2pF) scope probes with a wide bandwidth (1GHz) scope. Improper probing will give deceiving results.

Cables and Connectors, General Comments:

When choosing cable and connectors for LVDS it is important to remember:

Use controlled impedance media. The cables and connectors you use should have a matched differential impedance of about 100Ω . They should not introduce major impedance discontinuities.

Balanced cables (e.g. twisted pair) are usually better than unbalanced cables (ribbon cable, simple coax.) for noise reduction and signal quality. Balanced cables tend to generate less EMI due to field canceling effects and also tend to pick up electromagnetic radiation a common-mode (not differential mode) noise which is rejected by the receiver. For cable distances < 0.5M, most cables can be made to work effectively. For distances 0.5M \leq d \leq 10M, CAT 3 (category 3) twisted pair cable works well, is readily available and relatively inexpensive.

Fail-safe Feature:

The LVDS receiver is a high gain, high speed device that amplifies a small differential signal (20mV) to CMOS logic levels. Due to the high gain and tight threshold of the receiver, care should be taken to prevent noise from appearing as a valid signal.

The receiver's internal fail-safe circuitry is designed to source/sink a small amount of current, providing fail-safe protection (a stable known state of HIGH output voltage) for floating, terminated or shorted receiver inputs.

- 1. Open Input Pins. The DS90LV032A is a quad receiver device, and if an application requires only 1, 2 or 3 receivers, the unused channel(s) inputs should be left OPEN. Do not tie unused receiver inputs to ground or any other voltages. The input is biased by internal high value pull up and pull down resistors to set the output to a HIGH state. This internal circuitry will guarantee a HIGH, stable output state for open inputs.
- 2. Terminated Input. If the driver is disconnected (cable unplugged), or if the driver is in a TRI-STATE or power-off condition, the receiver output will again be in a HIGH state, even with the end of cable 100\Omega termination resistor across the input pins. The unplugged cable can become a floating antenna which can pick up noise. If the cable picks up more than 10mV of differential noise, the receiver may see the noise as a valid signal and switch. To insure that any noise is seen as common-mode and not differential, a balanced interconnect should be used. Twisted pair cable will offer better balance than flat ribbon cable.

Applications Information (Continued)

3. Shorted Inputs. If a fault condition occurs that shorts the receiver inputs together, thus resulting in a 0V differential input voltage, the receiver output will remain in a HIGH state. Shorted input fail-safe is not supported across the common-mode range of the device (GND to 2.4V). It is only supported with inputs shorted and no external common-mode voltage applied. External lower value pull up and pull down resistors (for a stronger bias) may be used to boost fail-safe in the presence of higher noise levels. The pull up and pull down resistors should be in the $5k\Omega$ to $15k\Omega$ range to minimize loading and waveform distortion to the driver. The common-mode bias point should be set to approximately 1.2V (less than 1.75V) to be compatible with the internal circuitry.

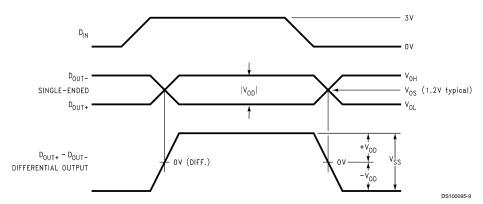


FIGURE 7. Driver Output Levels

Pin Descriptions

	-	
Pin No.	Name	Description
1, 7, 9, 15	D _{IN}	Driver input pin, TTL/CMOS compatible
2, 6, 10, 14	D _{OUT+}	Non-inverting driver output pin, LVDS levels
3, 5, 11, 13	D _{OUT}	Inverting driver output pin, LVDS levels
4	EN	Active high enable pin, OR-ed with EN*
12	EN*	Active low enable pin, OR-ed with EN
16	V _{cc}	Power supply pin, +3.3V ± 0.3V
8	GND	Ground pin

Ordering Information

Operating	Package Type/	Order Number		
Temperature	Number			
-40°C to +85°C	SOP/M16A	DS90LV031ATM		
-40°C to +85°C	TSSOP/MTC16	DS90LV031ATMTC		
	Temperature -40°C to +85°C	Temperature Number -40°C to +85°C SOP/M16A		

Operating	Package Type/	Order Number
Temperature	Number	
-55°C to +125°C	Cerpack/W16A I	S90LV031AW-QML

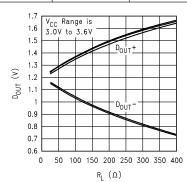


FIGURE 8. Typical DS90LV031A, D_{OUT} (single ended) vs R_L , T_A = 25°C

Applications Information (Continued)

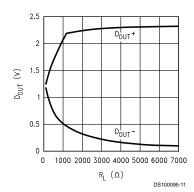
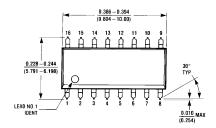
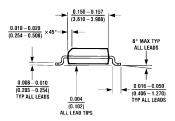
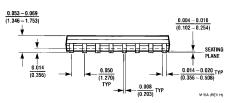


FIGURE 9. Typical DS90LV031A, D $_{\rm OUT}$ vs R $_{\rm L}$, V $_{\rm CC}$ = 3.3V, T $_{\rm A}$ = 25°C

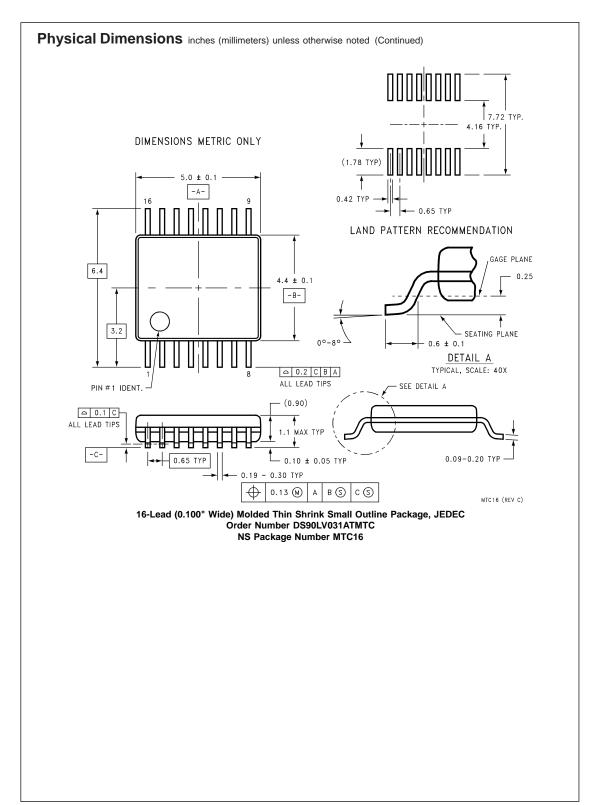
Physical Dimensions inches (millimeters) unless otherwise noted



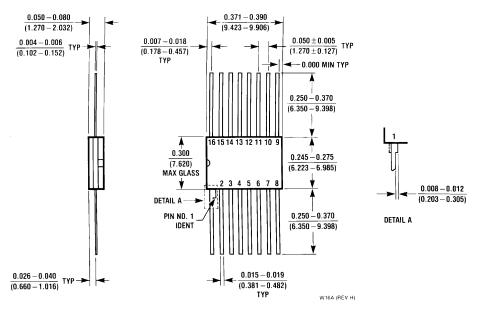




16-Lead (0.150" Wide) Molded Small Outline Package, JEDEC Order Number DS90LV031ATM NS Package Number M16A



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Cerpack Order Number DS90LV031AW-QML NS Package Number W16A

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- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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